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□□BEST□□□
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□□□BEST-507 250g□□
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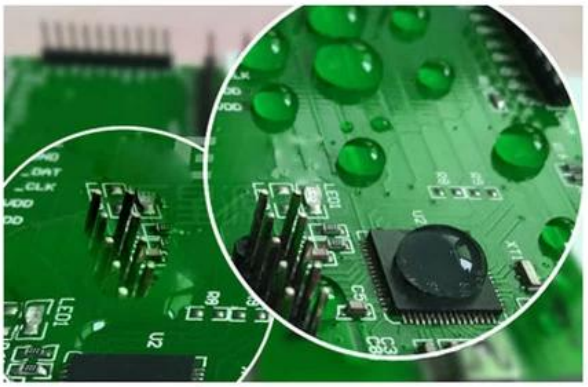
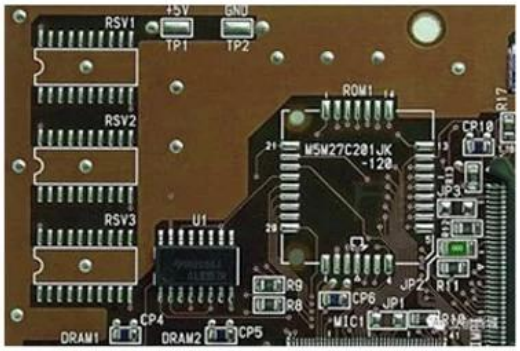
Product Usage

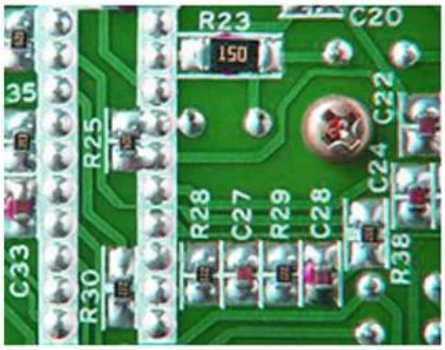
MODEL	BST-508
SHELF LIFE	6 months
INGREDIENT	Sn63/Pb37
WEIGHT	500g
MELTING POINT	183℃

Having a large insulation resistance does not corrode the PCB, and the requirements for no-cleaning can be achieved.



High impedance, full and bright solder, low residue



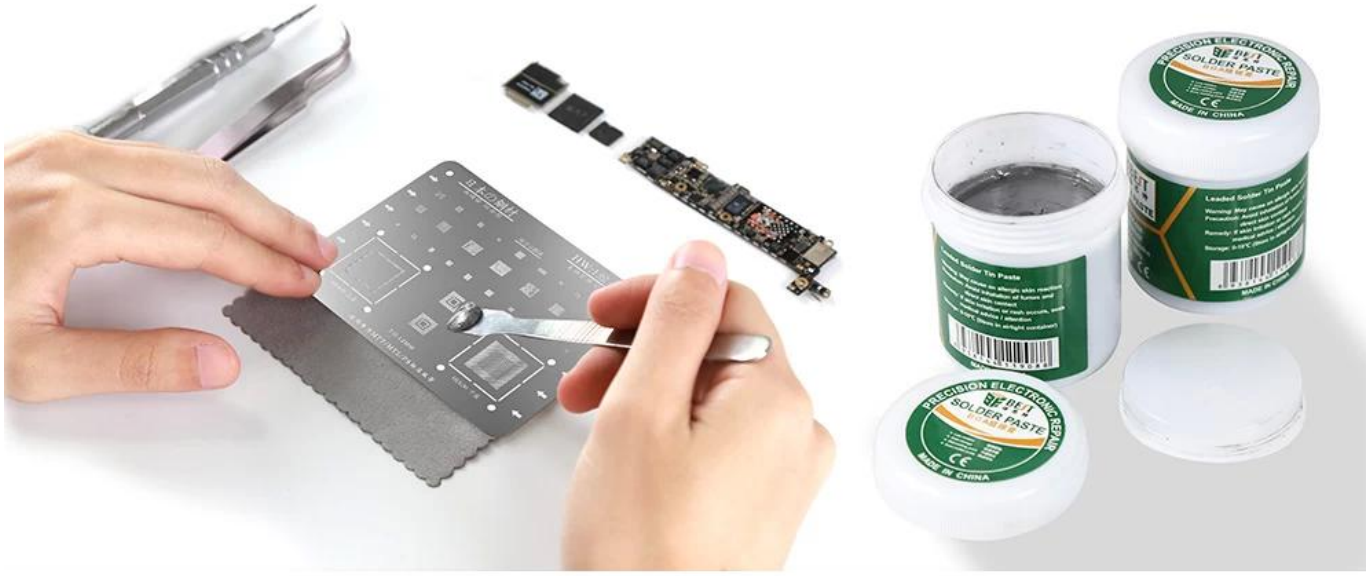


Welding requirements for a wide range of products

TESTING EFFECT

UNIFORM SOLDER JOINT

LOW TEMPERATURE MELTING POINT



PRODUCT SIZE